

# BLF7G21L-160P; BLF7G21LS-160P

Power LDMOS transistor

Rev. 4 — 1 September 2015

AMPLEON

Product data sheet

## 1. Product profile

### 1.1 General description

160 W LDMOS power transistor for base station applications at frequencies from 1800 MHz to 2050 MHz, also suitable for operation at 1495 MHz to 1511 MHz.

**Table 1. Typical performance**

Typical RF performance at  $T_{case} = 25\text{ °C}$  in a common source class-AB production test circuit.

| Mode of operation | f<br>(MHz)   | $I_{DQ}$<br>(mA) | $V_{DS}$<br>(V) | $P_{L(AV)}$<br>(W) | $G_p$<br>(dB) | $\eta_D$<br>(%) | ACPR<br>(dBc)           |
|-------------------|--------------|------------------|-----------------|--------------------|---------------|-----------------|-------------------------|
| 2-carrier W-CDMA  | 1930 to 1990 | 1080             | 28              | 45                 | 18            | 34              | -30 <a href="#">[1]</a> |
| 1-carrier W-CDMA  | 1930 to 1990 | 1080             | 28              | 50                 | 18.0          | 36              | -34 <a href="#">[2]</a> |

[1] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF; carrier spacing 5 MHz.

[2] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Designed for broadband operation (1800 MHz to 2050 MHz)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- RF power amplifiers for base stations and multi carrier applications in the 1800 MHz to 2050 MHz frequency range

## 2. Pinning information

Table 2. Pinning

| Pin                              | Description | Simplified outline | Graphic symbol                           |
|----------------------------------|-------------|--------------------|------------------------------------------|
| <b>BLF7G21L-160P (SOT1121A)</b>  |             |                    |                                          |
| 1                                | drain1      |                    | <p style="text-align: right;">sym117</p> |
| 2                                | drain2      |                    |                                          |
| 3                                | gate1       |                    |                                          |
| 4                                | gate2       |                    |                                          |
| 5                                | source      |                    |                                          |
| <b>BLF7G21LS-160P (SOT1121B)</b> |             |                    |                                          |
| 1                                | drain1      |                    | <p style="text-align: right;">sym117</p> |
| 2                                | drain2      |                    |                                          |
| 3                                | gate1       |                    |                                          |
| 4                                | gate2       |                    |                                          |
| 5                                | source      |                    |                                          |

[1] Connected to flange.

## 3. Ordering information

Table 3. Ordering information

| Type number    | Package |                                                           |          |
|----------------|---------|-----------------------------------------------------------|----------|
|                | Name    | Description                                               | Version  |
| BLF7G21L-160P  | -       | flanged LDMOST ceramic package; 2 mounting holes; 4 leads | SOT1121A |
| BLF7G21LS-160P | -       | earless flanged ceramic package; 4 leads                  | SOT1121B |

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter            | Conditions | Min  | Max  | Unit |
|-----------|----------------------|------------|------|------|------|
| $V_{DS}$  | drain-source voltage |            | -    | 65   | V    |
| $V_{GS}$  | gate-source voltage  |            | -0.5 | +13  | V    |
| $I_D$     | drain current        |            | -    | 32.5 | A    |
| $T_{stg}$ | storage temperature  |            | -65  | +150 | °C   |
| $T_j$     | junction temperature |            | -    | 200  | °C   |

## 5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol        | Parameter                                | Conditions                                    | Typ  | Unit |
|---------------|------------------------------------------|-----------------------------------------------|------|------|
| $R_{th(j-c)}$ | thermal resistance from junction to case | $T_{case} = 80\text{ °C}; P_L = 100\text{ W}$ | 0.41 | K/W  |

## 6. Characteristics

Table 6. Characteristics

$T_j = 25\text{ °C}$ ; per section unless otherwise specified.

| Symbol        | Parameter                        | Conditions                                                  | Min | Typ  | Max | Unit          |
|---------------|----------------------------------|-------------------------------------------------------------|-----|------|-----|---------------|
| $V_{(BR)DSS}$ | drain-source breakdown voltage   | $V_{GS} = 0\text{ V}; I_D = 0.9\text{ mA}$                  | 65  | -    | -   | V             |
| $V_{GS(th)}$  | gate-source threshold voltage    | $V_{DS} = 10\text{ V}; I_D = 90\text{ mA}$                  | 1.5 | 1.9  | 2.3 | V             |
| $I_{DSS}$     | drain leakage current            | $V_{GS} = 0\text{ V}; V_{DS} = 28\text{ V}$                 | -   | -    | 2   | $\mu\text{A}$ |
| $I_{DSX}$     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75\text{ V}; V_{DS} = 10\text{ V}$ | 14  | -    | -   | A             |
| $I_{GSS}$     | gate leakage current             | $V_{GS} = 11\text{ V}; V_{DS} = 0\text{ V}$                 | -   | -    | 200 | nA            |
| $g_{fs}$      | forward transconductance         | $V_{DS} = 10\text{ V}; I_D = 4.5\text{ A}$                  | -   | 7    | -   | S             |
| $R_{DS(on)}$  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75\text{ V}; I_D = 3.15\text{ A}$  | -   | 0.15 | -   | $\Omega$      |

## 7. Test information

Table 7. Application information

Mode of operation: 2-carrier W-CDMA; PAR 8.4 dB at 0.01 % probability on CCDF; 3GPP test model 1; 64 PDPCH;  $f_1 = 1932.5\text{ MHz}$ ;  $f_2 = 1937.5\text{ MHz}$ ;  $f_3 = 1982.5\text{ MHz}$ ;  $f_4 = 1987.5\text{ MHz}$ ; RF performance at  $V_{DS} = 28\text{ V}$ ;  $I_{Dq} = 1080\text{ mA}$ ;  $T_{case} = 25\text{ °C}$ ; unless otherwise specified; in a class-AB production test circuit.

| Symbol       | Parameter                             | Conditions                | Min  | Typ  | Max | Unit |
|--------------|---------------------------------------|---------------------------|------|------|-----|------|
| $G_p$        | power gain                            | $P_{L(AV)} = 45\text{ W}$ | 17.0 | 18.0 | -   | dB   |
| $RL_{in}$    | input return loss                     | $P_{L(AV)} = 45\text{ W}$ | -    | -15  | -8  | dB   |
| $\eta_D$     | drain efficiency                      | $P_{L(AV)} = 45\text{ W}$ | 31   | 34   | -   | %    |
| $ACPR_{5M}$  | adjacent channel power ratio (5 MHz)  | $P_{L(AV)} = 45\text{ W}$ | -    | -30  | -25 | dBc  |
| $ACPR_{10M}$ | adjacent channel power ratio (10 MHz) | $P_{L(AV)} = 45\text{ W}$ | -    | -    | -   | dBc  |

Table 8. Application information

Mode of operation: 1-carrier W-CDMA; PAR 7.2 dB at 0.01 % probability on CCDF; 3GPP test model 1; 64 PDPCH;  $f_1 = 1932.5\text{ MHz}$ ;  $f_2 = 1987.5\text{ MHz}$ ; RF performance at  $V_{DS} = 28\text{ V}$ ;  $I_{Dq} = 1080\text{ mA}$ ;  $T_{case} = 25\text{ °C}$ ; unless otherwise specified; in a class-AB production test circuit.

| Symbol  | Parameter                    | Conditions                                                | Min | Typ | Max | Unit |
|---------|------------------------------|-----------------------------------------------------------|-----|-----|-----|------|
| $PAR_O$ | output peak-to-average ratio | $P_{L(AV)} = 80\text{ W}$ ; at 0.01 % probability on CCDF | 4.0 | 4.5 | -   | dB   |

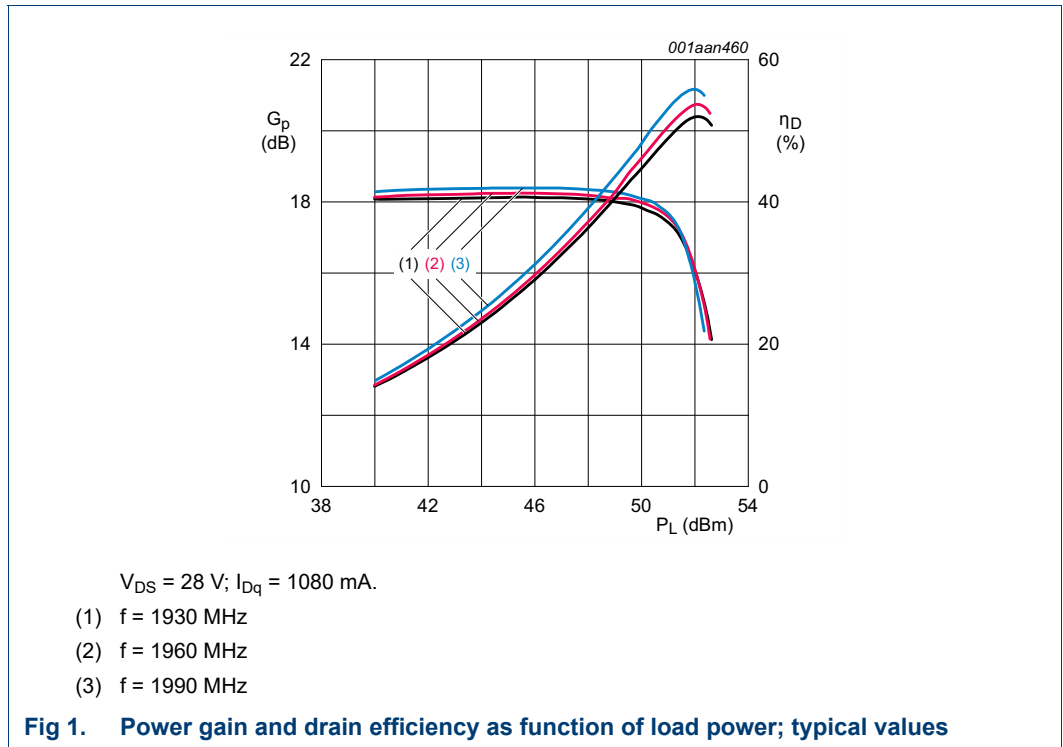
**7.1 Ruggedness in class-AB operation**

The BLF7G21L-160P and BLF7G21LS-160P are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:

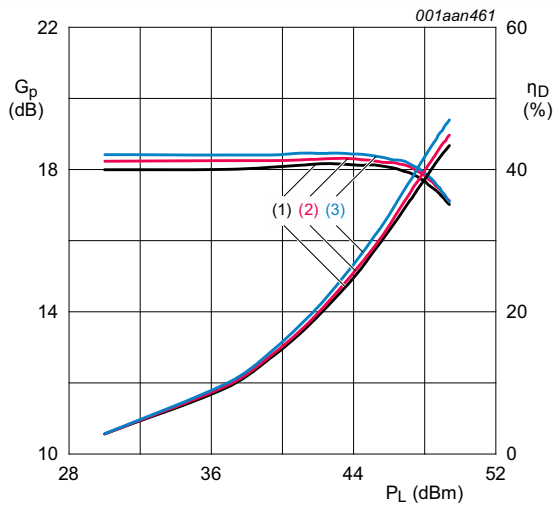
$V_{DS} = 28\text{ V}$ ;  $I_{Dq} = 1080\text{ mA}$ ;  $P_L = 160\text{ W (CW)}$ ,  $f = 1805\text{ MHz}$ ,

$V_{DS} = 28\text{ V}$ ;  $I_{Dq} = 350\text{ mA}$ ;  $P_L = 31.6\text{ W (IS-95)}$ ;  $P_L = 90\text{ W (pulsed CW, } \delta = 10\% \text{, } t_p = 100\text{ }\mu\text{s, per section)}$ ,  $f = 1495\text{ MHz}$ .

**7.2 CW**

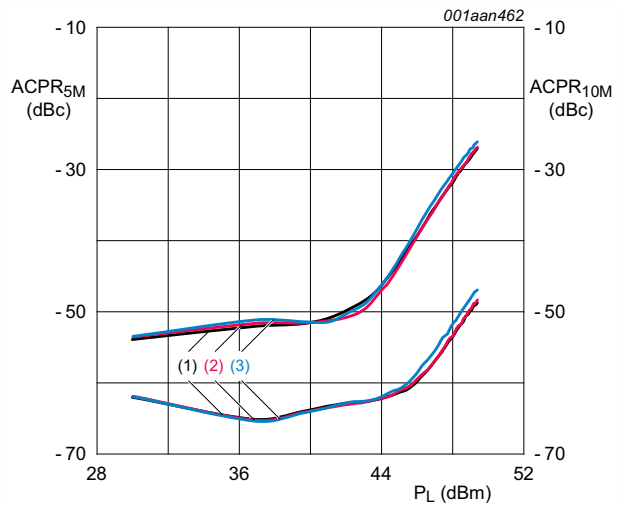


7.3 1-Carrier W-CDMA



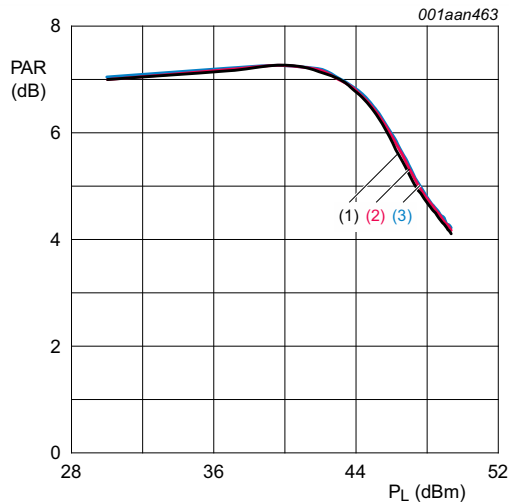
$V_{DS} = 28\text{ V}; I_{Dq} = 1080\text{ mA}.$   
 (1)  $f = 1930\text{ MHz}$   
 (2)  $f = 1960\text{ MHz}$   
 (3)  $f = 1990\text{ MHz}$

**Fig 2. Power gain and drain efficiency as function of load power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 1080\text{ mA}.$   
 (1)  $f = 1930\text{ MHz}$   
 (2)  $f = 1960\text{ MHz}$   
 (3)  $f = 1990\text{ MHz}$

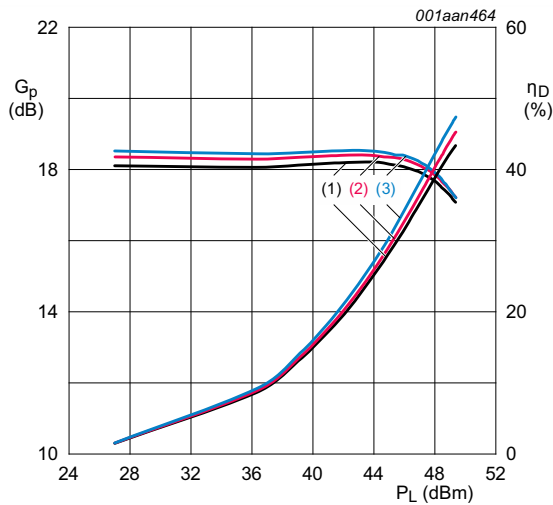
**Fig 3. Adjacent channel power ratio (5 MHz) and adjacent channel power ratio (10 MHz) as a function of load power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 1080\text{ mA}.$   
 (1)  $f = 1930\text{ MHz}$   
 (2)  $f = 1960\text{ MHz}$   
 (3)  $f = 1990\text{ MHz}$

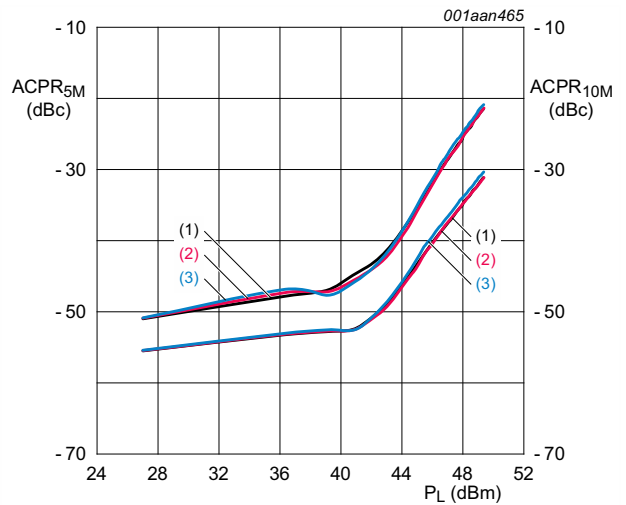
**Fig 4. Peak-to-average ratio as a function of load power; typical values**

7.4 2-Carrier W-CDMA 5 MHz



$V_{DS} = 28\text{ V}; I_{Dq} = 1080\text{ mA}$ .  
 (1)  $f = 1930\text{ MHz}$   
 (2)  $f = 1960\text{ MHz}$   
 (3)  $f = 1990\text{ MHz}$

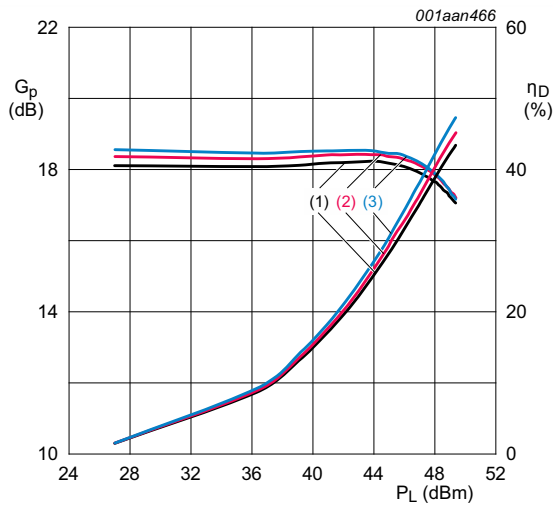
**Fig 5. Power gain and drain efficiency as function of load power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 1080\text{ mA}$ .  
 (1)  $f = 1930\text{ MHz}$   
 (2)  $f = 1960\text{ MHz}$   
 (3)  $f = 1990\text{ MHz}$

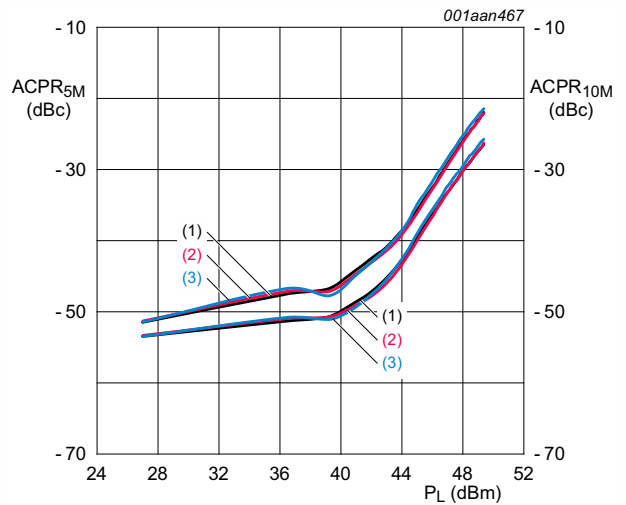
**Fig 6. Adjacent channel power ratio (5 MHz) and adjacent channel power ratio (10 MHz) as a function of load power; typical values**

7.5 2-Carrier W-CDMA 10 MHz



$V_{DS} = 28\text{ V}; I_{Dq} = 1080\text{ mA.}$   
 (1)  $f = 1930\text{ MHz}$   
 (2)  $f = 1960\text{ MHz}$   
 (3)  $f = 1990\text{ MHz}$

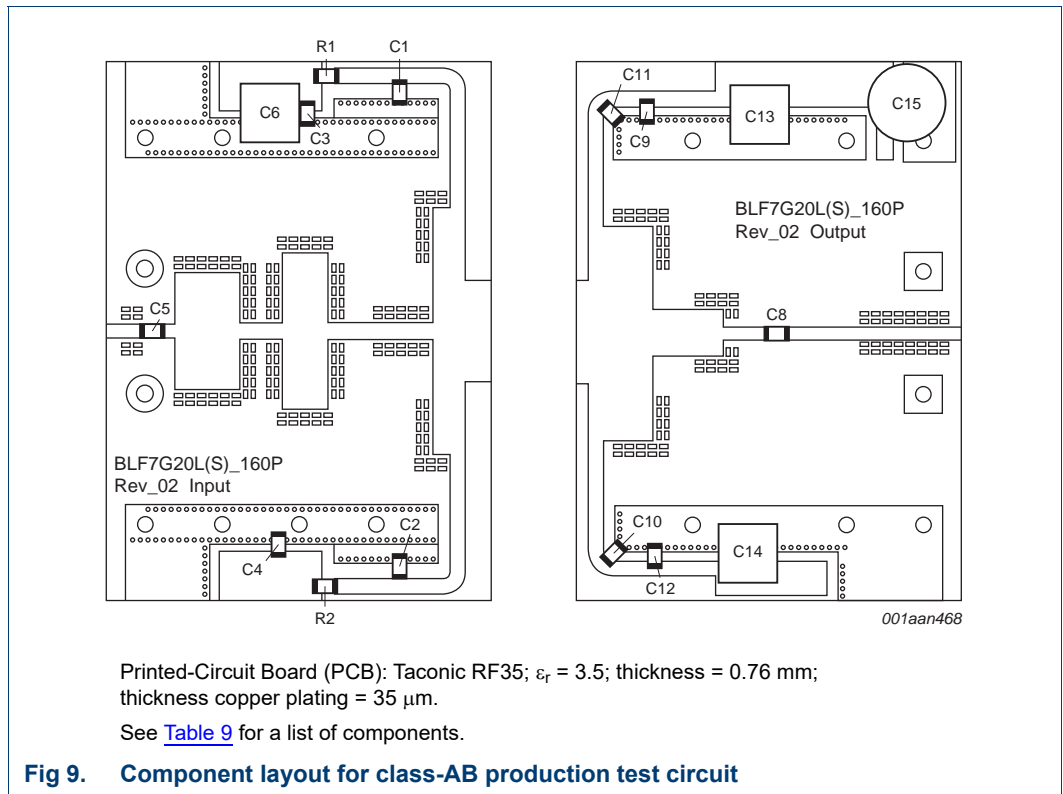
**Fig 7. Power gain and drain efficiency as function of load power; typical values**



$V_{DS} = 28\text{ V}; I_{Dq} = 1080\text{ mA.}$   
 (1)  $f = 1930\text{ MHz}$   
 (2)  $f = 1960\text{ MHz}$   
 (3)  $f = 1990\text{ MHz}$

**Fig 8. Adjacent channel power ratio (5 MHz) and adjacent channel power ratio (10 MHz) as a function of load power; typical values**

7.6 Test circuit



**Table 9. List of components**

For test circuit see [Figure 9](#).

| Component           | Description                       | Value                    | Remarks      |
|---------------------|-----------------------------------|--------------------------|--------------|
| C1, C2, C5, C9, C10 | multilayer ceramic chip capacitor | 68 pF                    | [1]          |
| C3, C4, C11, C12    | multilayer ceramic chip capacitor | 820 pF                   | [2]          |
| C6, C13, C14        | multilayer ceramic chip capacitor | 10 $\mu\text{F}$         | [3]          |
| C8                  | multilayer ceramic chip capacitor | 10 pF                    | [1]          |
| C15                 | electrolytic capacitor            | 470 $\mu\text{F}$ ; 63 V |              |
| R1, R2              | SMD resistor                      | 12 $\Omega$              | Philips 1206 |

[1] American Technical Ceramics type 800B or capacitor of same quality.

[2] American Technical Ceramics type 100A or capacitor of same quality.

[3] TDK or capacitor of same quality.

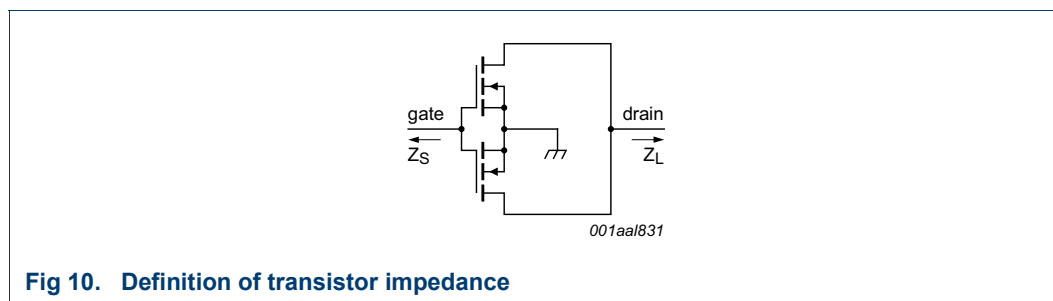


### 7.7 Impedance information

**Table 10. Typical impedance**

*Typical values valid for both section in parallel unless otherwise specified.*

| <b>f</b><br><b>MHz</b> | <b>Z<sub>S</sub></b><br><b>Ω</b> | <b>Z<sub>L</sub></b><br><b>Ω</b> |
|------------------------|----------------------------------|----------------------------------|
| 1750                   | 0.99 – j4.09                     | 2.32 – j2.35                     |
| 1805                   | 1.12 – j4.39                     | 2.20 – j2.20                     |
| 1840                   | 1.23 – j4.58                     | 2.08 – j2.14                     |
| 1880                   | 1.31 – j4.74                     | 1.94 – j2.12                     |
| 1930                   | 1.49 – j5.01                     | 1.76 – j2.15                     |
| 1960                   | 1.61 – j5.19                     | 1.66 – j2.20                     |
| 1990                   | 1.75 – j5.36                     | 1.56 – j2.26                     |
| 2020                   | 1.91 – j5.54                     | 1.48 – j2.34                     |
| 2050                   | 2.13 – j5.75                     | 1.4 – j2.42                      |

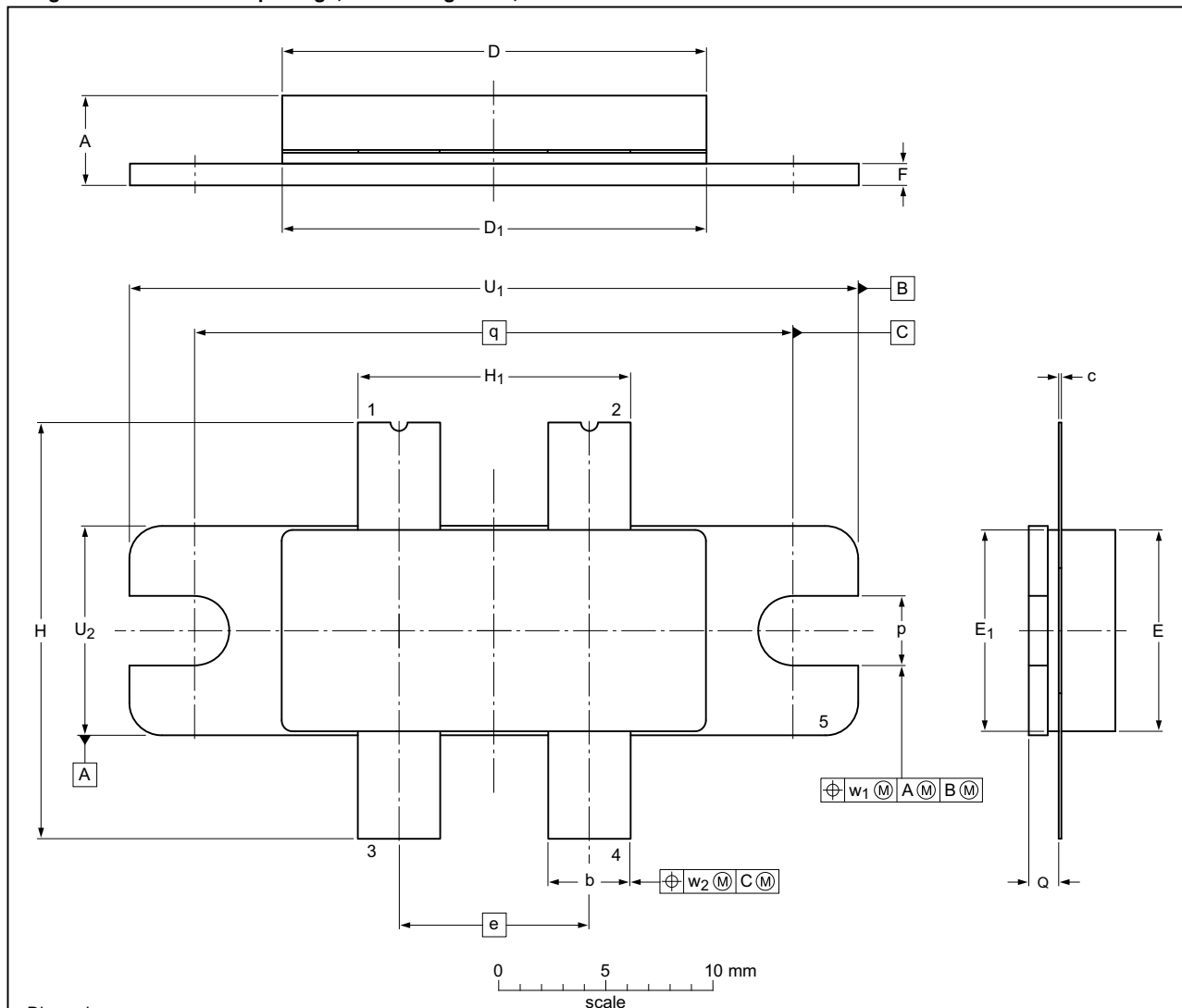


**Fig 10. Definition of transistor impedance**

8. Package outline

Flanged LDMOST ceramic package; 2 mounting holes; 4 leads

SOT1121A



Dimensions

| Unit <sup>(1)</sup> | A   | b     | c     | D     | D <sub>1</sub> | e     | E     | E <sub>1</sub> | F     | H     | H <sub>1</sub> | p     | Q <sup>(2)</sup> | q     | U <sub>1</sub> | U <sub>2</sub> | w <sub>1</sub> | w <sub>2</sub> |
|---------------------|-----|-------|-------|-------|----------------|-------|-------|----------------|-------|-------|----------------|-------|------------------|-------|----------------|----------------|----------------|----------------|
| mm                  | max | 4.75  | 3.94  | 0.18  | 20.02          | 19.96 | 9.53  | 9.53           | 1.14  | 19.94 | 12.83          | 3.38  | 1.70             | 34.16 | 9.91           |                | 0.25           | 0.51           |
|                     | nom |       |       |       |                | 8.89  |       |                |       |       |                |       | 27.94            |       |                |                |                |                |
|                     | min | 3.45  | 3.68  | 0.10  | 19.61          | 19.66 | 9.27  | 9.27           | 0.89  | 18.92 | 12.57          | 3.12  | 1.45             | 33.91 | 9.65           |                |                |                |
| inches              | max | 0.187 | 0.155 | 0.007 | 0.788          | 0.786 | 0.375 | 0.375          | 0.045 | 0.785 | 0.505          | 0.133 | 0.067            | 1.345 | 0.39           |                | 0.01           | 0.02           |
|                     | nom |       |       |       |                | 0.35  |       |                |       |       |                |       | 1.1              |       |                |                |                |                |
|                     | min | 0.136 | 0.145 | 0.004 | 0.772          | 0.774 | 0.365 | 0.365          | 0.035 | 0.745 | 0.495          | 0.123 | 0.057            | 1.335 | 0.38           |                |                |                |

Note

- 1. millimeter dimensions are derived from the original inch dimensions.
- 2. dimension is measured 0.030 inch (0.76 mm) from the body.

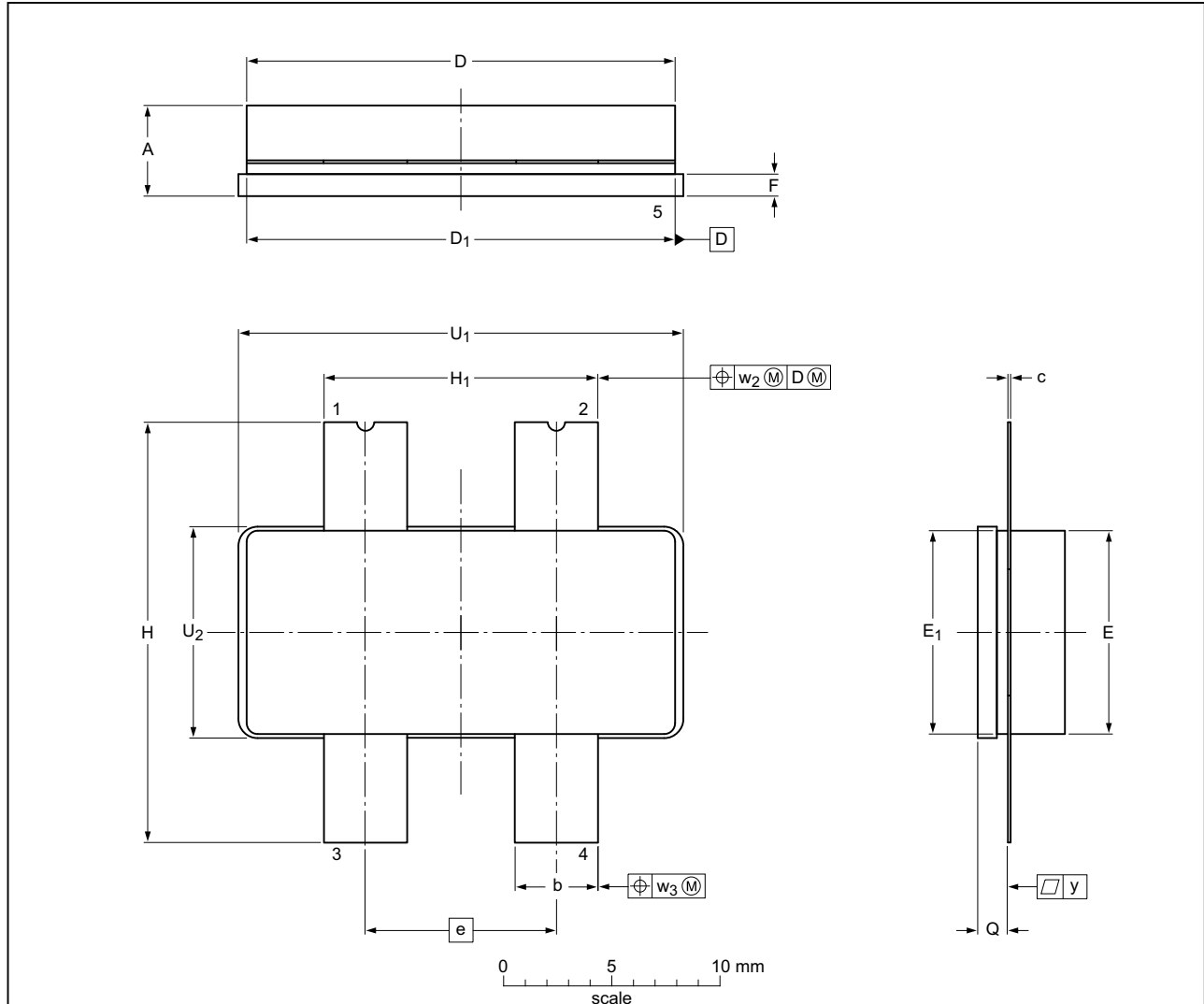
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| Outline version | References |       |       | European projection | Issue date           |
|-----------------|------------|-------|-------|---------------------|----------------------|
|                 | IEC        | JEDEC | JEITA |                     |                      |
| SOT1121A        |            |       |       |                     | 09-10-12<br>10-02-02 |

Fig 11. Package outline SOT1121A

Earless flanged ceramic package; 4 leads

SOT1121B



Dimensions

| Unit <sup>(1)</sup> | A   | b     | c     | D     | D <sub>1</sub> | e     | E     | E <sub>1</sub> | F     | H     | H <sub>1</sub> | Q     | U <sub>1</sub> | U <sub>2</sub> | w <sub>2</sub> | w <sub>3</sub> | y    |
|---------------------|-----|-------|-------|-------|----------------|-------|-------|----------------|-------|-------|----------------|-------|----------------|----------------|----------------|----------------|------|
| mm                  | max | 4.75  | 3.94  | 0.18  | 20.02          | 19.96 | 9.53  | 9.53           | 1.14  | 19.94 | 12.83          | 1.70  | 20.70          | 9.91           | 0.51           | 0.25           | 0.25 |
|                     | nom |       |       |       |                | 8.89  |       |                |       |       |                |       |                |                |                |                |      |
|                     | min | 3.45  | 3.68  | 0.08  | 19.61          | 19.66 | 9.27  | 9.27           | 0.89  | 18.92 | 12.57          | 1.45  | 20.45          | 9.65           |                |                |      |
| inches              | max | 0.187 | 0.155 | 0.007 | 0.788          | 0.786 | 0.375 | 0.375          | 0.045 | 0.785 | 0.505          | 0.067 | 0.815          | 0.39           | 0.02           | 0.01           | 0.01 |
|                     | nom |       |       |       |                | 0.35  |       |                |       |       |                |       |                |                |                |                |      |
|                     | min | 0.136 | 0.145 | 0.003 | 0.772          | 0.774 | 0.365 | 0.365          | 0.035 | 0.745 | 0.495          | 0.057 | 0.805          | 0.38           |                |                |      |

Note

1. millimeter dimensions are derived from the original inch dimensions.
2. dimension is measured 0.030 inch (0.76 mm) from the body.

sot1121b\_po

| Outline version | References |       |       | European projection | Issue date           |
|-----------------|------------|-------|-------|---------------------|----------------------|
|                 | IEC        | JEDEC | JEITA |                     |                      |
| SOT1121B        |            |       |       |                     | 09-12-14<br>12-06-07 |

Fig 12. Package outline SOT1121B

## 9. Abbreviations

Table 11. Abbreviations

| Acronym | Description                                             |
|---------|---------------------------------------------------------|
| 3GPP    | 3rd Generation Partnership Project                      |
| CCDF    | Complementary Cumulative Distribution Function          |
| CW      | Continuous Wave                                         |
| DPCH    | Dedicated Physical CHannel                              |
| ESD     | ElectroStatic Discharge                                 |
| IS-95   | Interim Standard 95                                     |
| LDMOS   | Laterally Diffused Metal Oxide Semiconductor            |
| LDMOST  | Laterally Diffused Metal Oxide Semiconductor Transistor |
| PAR     | Peak-to-Average Ratio                                   |
| PDPCH   | transmission Power of the Dedicated Physical CHannel    |
| SMD     | Surface Mounted Device                                  |
| VSWR    | Voltage Standing Wave Ratio                             |
| W-CDMA  | Wideband Code Division Multiple Access                  |

## 10. Revision history

Table 12. Revision history

| Document ID                   | Release date                                                                                                                                                                                                                               | Data sheet status    | Change notice | Supersedes                    |
|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|---------------|-------------------------------|
| BLF7G21L-160P_7G21LS-160P#4   | 20150901                                                                                                                                                                                                                                   | Product data sheet   | -             | BLF7G21L-160P_7G21LS-160P v.3 |
| Modifications:                | <ul style="list-style-type: none"> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                      |               |                               |
| BLF7G21L-160P_7G21LS-160P v.3 | 20140210                                                                                                                                                                                                                                   | Product data sheet   | -             | BLF7G21L-160P_7G21LS-160P v.2 |
| BLF7G21L-160P_7G21LS-160P v.2 | 20111013                                                                                                                                                                                                                                   | Product data sheet   | -             | BLF7G21L-160P_7G21LS-160P v.1 |
| BLF7G21L-160P_7G21LS-160P v.1 | 20110401                                                                                                                                                                                                                                   | Objective data sheet | -             | -                             |

## 11. Legal information

### 11.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.ampleon.com>.

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